

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number:	SIRA24DP-T1-GE3
Manufacturer:	Vishay Siliconix
Package:	Please confirm with sales
Availability:	Please confirm with sales

Product Page:

<https://antrexco.com/product/details/vishay-siliconix/sira24dp-t1-ge3.html>

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Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

N-Channel 25 V (D-S) MOSFET



PRODUCT SUMMARY	
V_{DS} (V)	25
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10$ V	0.00140
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5$ V	0.00240
Q_g typ. (nC)	17.2
I_D (A)	60 ^{a, g}
Configuration	Single

ORDERING INFORMATION	
Package	PowerPAK SO-8 Single
Lead (Pb)-free and halogen-free	SiRA24DP-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise noted)				
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage	V_{DS}	25	V	
Gate-source voltage	V_{GS}	+20 / -16		
Continuous drain current ($T_J = 150^\circ\text{C}$)	$T_C = 25^\circ\text{C}$	60 ^a	A	
	$T_C = 70^\circ\text{C}$	60 ^a		
	$T_A = 25^\circ\text{C}$	44.5 ^{b, c}		
	$T_A = 70^\circ\text{C}$	35.6 ^{b, c}		
Pulsed drain current ($t = 100 \mu\text{s}$)	I_{DM}	150		
Continuous source-drain diode current	$T_C = 25^\circ\text{C}$	56.8		
	$T_A = 25^\circ\text{C}$	4.5 ^{b, c}		
Single pulse avalanche current	I_{AS}	30		
Single pulse avalanche energy	E_{AS}	45	mJ	
Maximum power dissipation	$T_C = 25^\circ\text{C}$	62.5	W	
	$T_C = 70^\circ\text{C}$	40		
	$T_A = 25^\circ\text{C}$	5 ^{b, c}		
	$T_A = 70^\circ\text{C}$	3.2 ^{b, c}		
Operating junction and storage temperature range	T_J, T_{stg}	-55 to +150	$^\circ\text{C}$	
Soldering recommendations (peak temperature) ^c		260		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^b	$t \leq 10$ s	R_{thJA}	20	25	$^\circ\text{C}/\text{W}$
Maximum junction-to-case (drain)	Steady state	R_{thJC}	1.7	2	

Notes

- Package limited.
- Surface mounted on 1" x 1" FR4 board.
- $t = 10$ s.
- See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- Maximum under steady state conditions is $70^\circ\text{C}/\text{W}$.
- $T_C = 25^\circ\text{C}$.

FEATURES

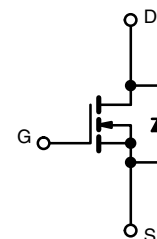
- TrenchFET[®] Gen IV power MOSFET
- Optimized Q_g , Q_{gd} , and Q_{gd}/Q_{gs} ratio reduces switching related power loss
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- Synchronous rectification
- High power density DC/DC
- Synchronous buck converter
- Load switching



N-Channel MOSFET



SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	25	-	-	V	
V _{DS} temperature coefficient	ΔV _{DS} /T _J	I _D = 10 mA	-	21	-	mV/°C	
V _{GS(th)} temperature coefficient	ΔV _{GS(th)} /T _J	I _D = 250 μA	-	-4.8	-		
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	1	-	2.1	V	
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = +20 / -16 V	-	-	100	nA	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 25 V, V _{GS} = 0 V	-	-	1	μA	
		V _{DS} = 25 V, V _{GS} = 0 V, T _J = 70 °C	-	-	15		
On-state drain current ^a	I _{D(on)}	V _{DS} ≥ 10 V, V _{GS} = 10 V	40	-	-	A	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 15 A	-	0.00115	0.00140	Ω	
		V _{GS} = 4.5 V, I _D = 10 A	-	0.00195	0.00240		
Forward transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 15 A	-	75	-	S	
Dynamic ^b							
Input capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	-	2650	-	pF	
Output capacitance	C _{oss}		-	1015	-		
Reverse transfer capacitance	C _{rss}		-	197	-		
Total gate charge	Q _g	V _{DS} = 10 V, V _{GS} = 10 V, I _D = 15 A	-	36.5	55	nC	
		V _{DS} = 10 V, V _{GS} = 4.5 V, I _D = 15 A	-	17.2	26		
Gate-source charge	Q _{gs}		-	7.4	-		
Gate-drain charge	Q _{gd}		-	3.3	-		
Gate resistance	R _g	f = 1 MHz	0.2	0.75	1.35	Ω	
Turn-on delay time	t _{d(on)}	V _{DD} = 10 V, R _L = 1 Ω, I _D ≅ 15 A, V _{GEN} = 10 V, R _g = 1 Ω	-	12	24	ns	
Rise time	t _r		-	23	46		
Turn-off delay time	t _{d(off)}		-	18	36		
Fall time	t _f		-	10	20		
Turn-on delay time	t _{d(on)}	V _{DD} = 10 V, R _L = 1 Ω, I _D ≅ 15 A, V _{GEN} = 4.5 V, R _g = 1 Ω	-	18	36		
Rise time	t _r		-	42	84		
Turn-off delay time	t _{d(off)}		-	17	34		
Fall time	t _f		-	17	34		
Drain-Source Body Diode Characteristics							
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	56.8	A	
Pulse diode forward current	I _{SM}		-	-	150		
Body diode voltage	V _{SD}	I _S = 5 A, V _{GS} = 0 V	-	0.73	1.1	V	
Body diode reverse recovery time	t _{rr}	I _F = 10 A, dI/dt = 100 A/μs, T _J = 25 °C	-	32	64	ns	
Body diode reverse recovery charge	Q _{rr}		-	20	40	nC	
Reverse recovery fall time	t _a		-	17	-	ns	
Reverse recovery rise time	t _b		-	15	-		

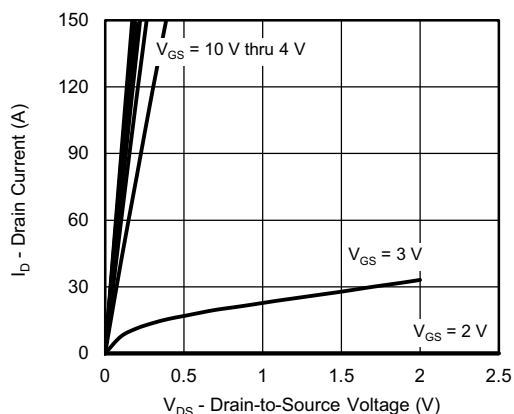
Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

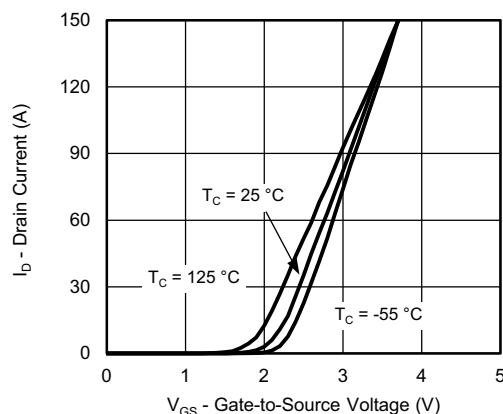
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



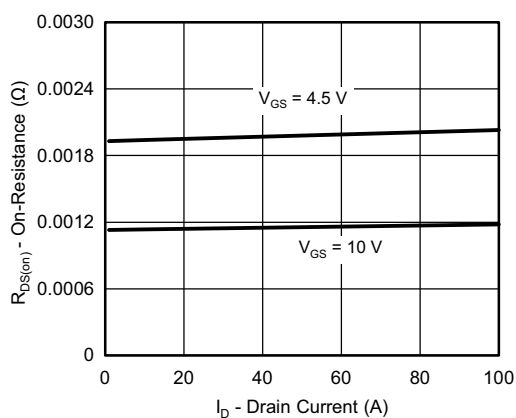
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



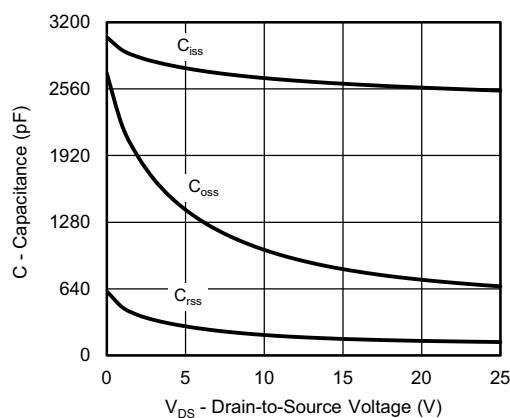
Output Characteristics



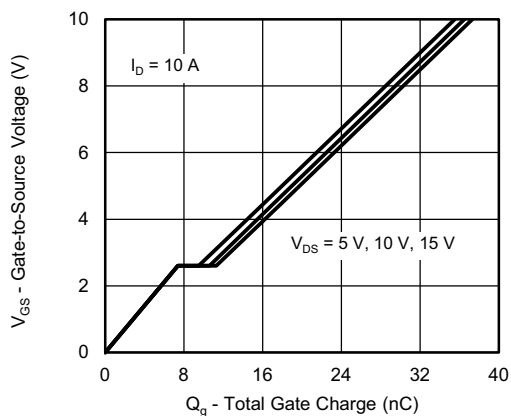
Transfer Characteristics



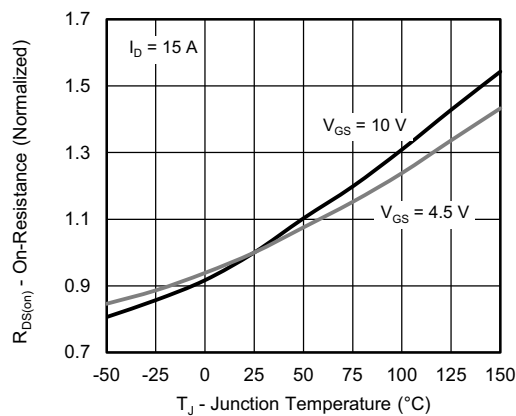
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



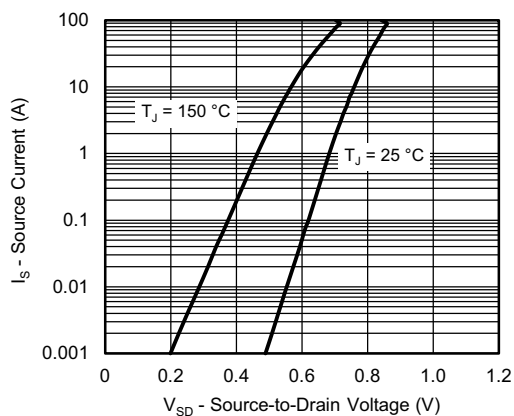
Gate Charge



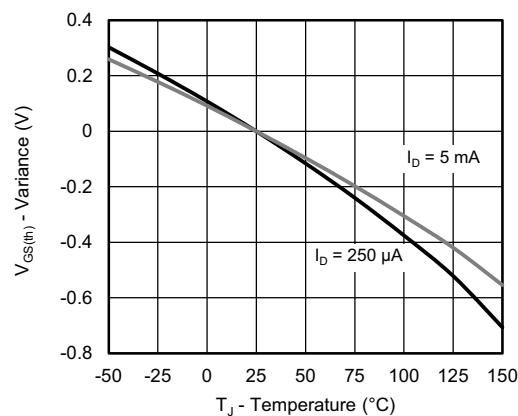
On-Resistance vs. Junction Temperature



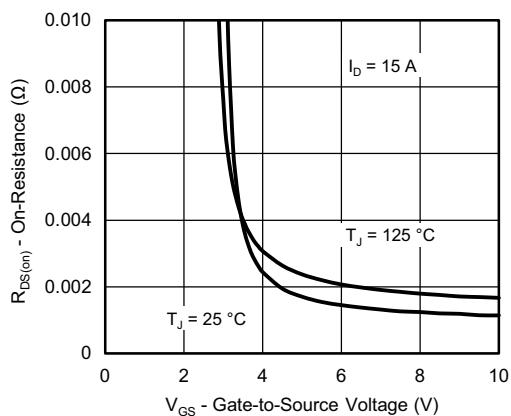
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



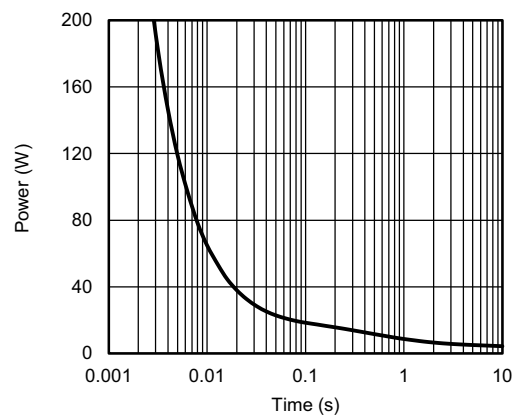
Source-Drain Diode Forward Voltage



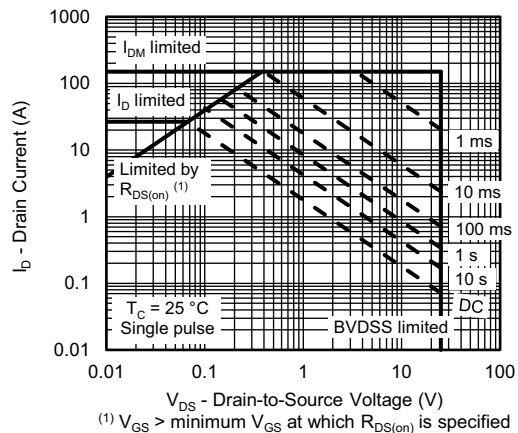
Threshold Voltage



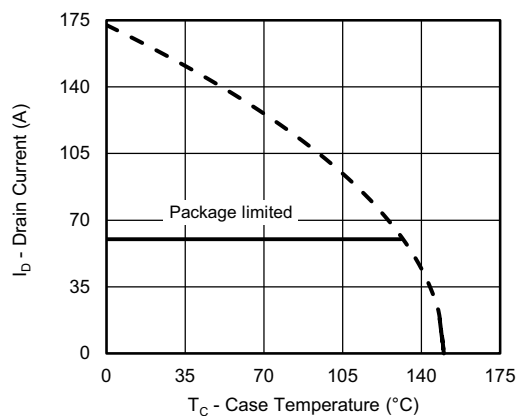
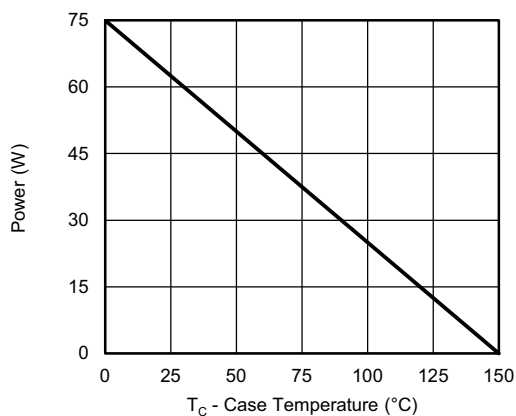
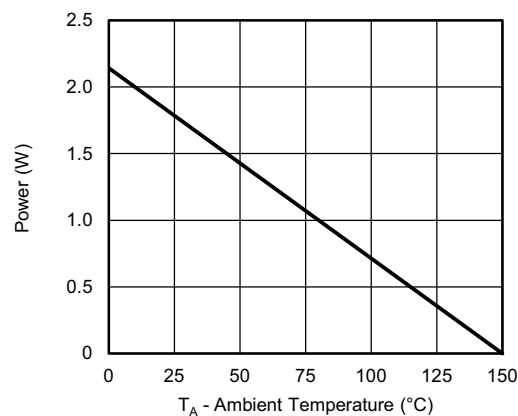
On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



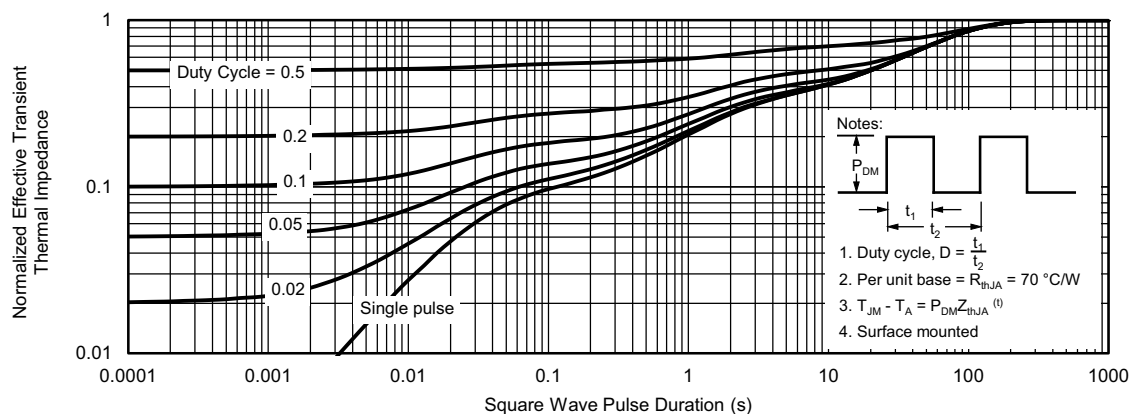
Safe Operating Area, Junction-to-Ambient

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Current Derating ^a

Power, Junction-to-Case

Power, Junction-to-Ambient
Note

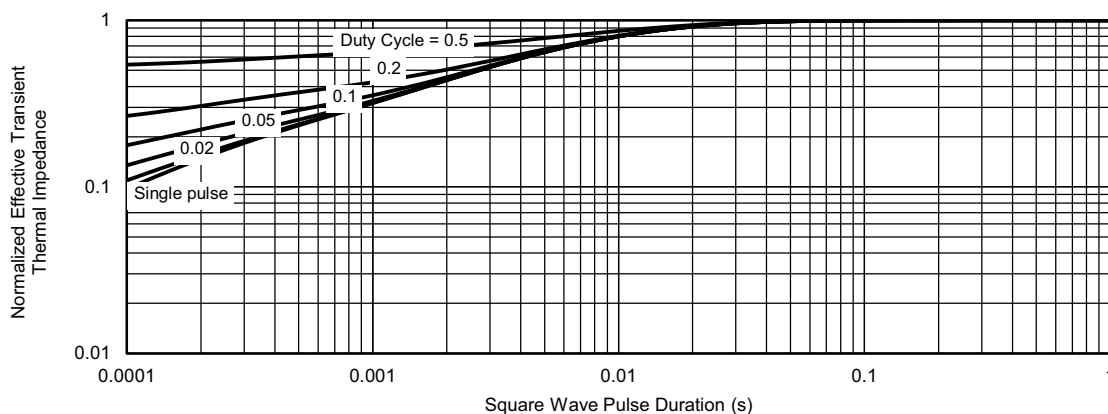
- a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



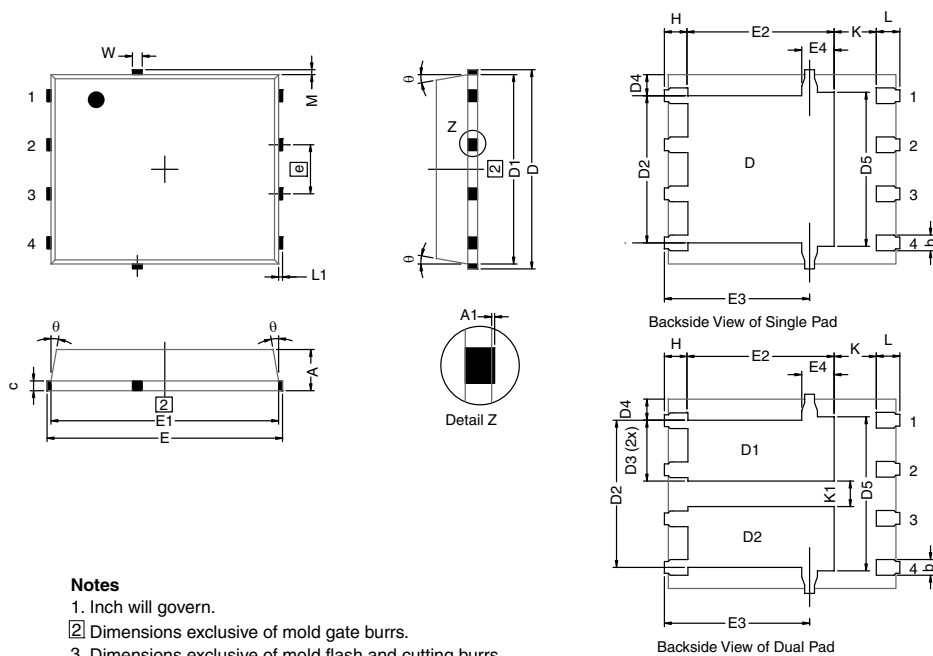
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

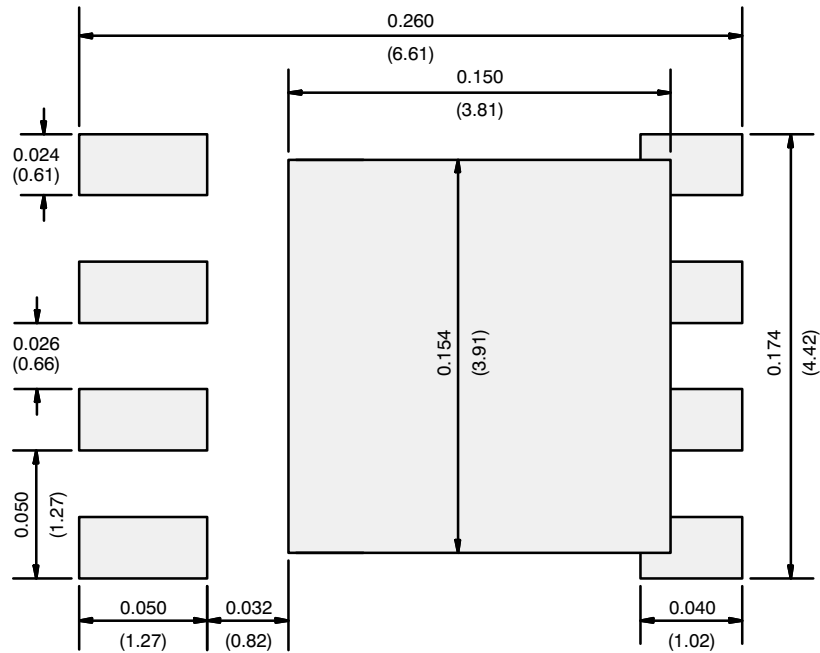
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PowerPAK® SO-8, (Single/Dual)



DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.97	1.04	1.12	0.038	0.041	0.044
A1		-	0.05	0	-	0.002
b	0.33	0.41	0.51	0.013	0.016	0.020
c	0.23	0.28	0.33	0.009	0.011	0.013
D	5.05	5.15	5.26	0.199	0.203	0.207
D1	4.80	4.90	5.00	0.189	0.193	0.197
D2	3.56	3.76	3.91	0.140	0.148	0.154
D3	1.32	1.50	1.68	0.052	0.059	0.066
D4	0.57 typ.			0.0225 typ.		
D5	3.98 typ.			0.157 typ.		
E	6.05	6.15	6.25	0.238	0.242	0.246
E1	5.79	5.89	5.99	0.228	0.232	0.236
E2	3.48	3.66	3.84	0.137	0.144	0.151
E3	3.68	3.78	3.91	0.145	0.149	0.154
E4	0.75 typ.			0.030 typ.		
e	1.27 BSC			0.050 BSC		
K	1.27 typ.			0.050 typ.		
K1	0.56	-	-	0.022	-	-
H	0.51	0.61	0.71	0.020	0.024	0.028
L	0.51	0.61	0.71	0.020	0.024	0.028
L1	0.06	0.13	0.20	0.002	0.005	0.008
θ	0°	-	12°	0°	-	12°
W	0.15	0.25	0.36	0.006	0.010	0.014
M	0.125 typ.			0.005 typ.		
ECN: S17-0173-Rev. L, 13-Feb-17						
DWG: 5881						

RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads
Dimensions in Inches/(mm)

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